

LEADED

# BGA SOLDER PASTE

● ● ●  
Sn63/Pb37

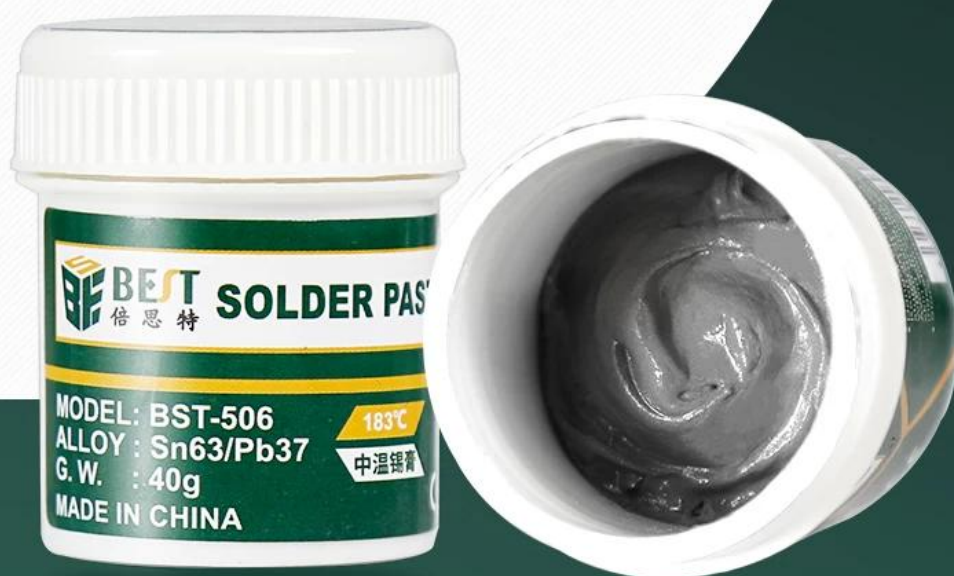
Melting point 183°C



## Product Usage

● ● ●  
TIN PASTE

Type number	BST-506
Types of	Solder Paste
Composition	Sn63/Pb37
Melting point	183°C
G.W.	40g
size	38*32mm



Sn63/Pb37

Melting point at medium temperature

183°C

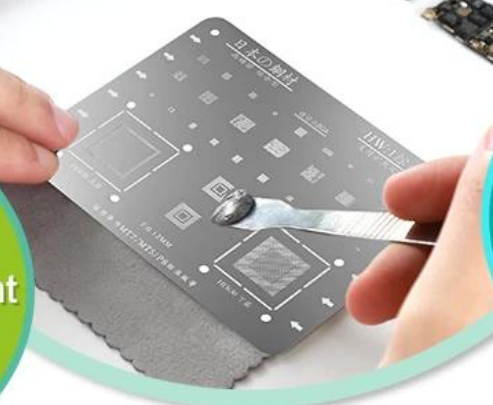




Low residue



Solder spot bright



Rapid welding



# Welding requirements for a wide range of products



SMT  
patch



LED  
patch



BGA  
welding



# Product List

G.W.:40g

